



# **Switching Diode**

## **Features**

- Fast Switching Speed
- Power Dissipation of 200mW
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- RoHS Compliant



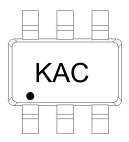


Marking: .KAC

**SOT-363** 

## **Applications**

- Electronic computer
- Pulse
- Switching circuit



### Pin definition

## **Mechanical Data**

• Package: SOT-363

• Lead Finish:Matte Tin

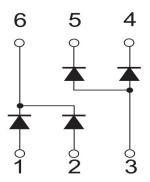
• Case Material: "Green" Molding Compound

• UL Flammability Classification Rating 94V-0

• Moisture Sensitivity: Level 3 per J-STD-020



## **Epuivalent circuit**





Maximum Ratings & Electrical Characteristics(TA=25°C unless otherwise noted)				
Parameter	Symbol	Value	Unit	
Repetitive Peak Reverse voltage	V <sub>RRM</sub>	75	V	
Working Peak Reverse Voltage	$V_{RWM}$	75	V	
Reverse voltage	V <sub>R</sub>	75	V	
Average rectified output current	Io	150	mA	
Non-repetitive pak frward crrent	I <sub>FM</sub>	300	mA	
Non-repetitive Peak Forward Surge Current@t=8.3ms	I <sub>FSM</sub>	2	А	
Power Dissipation	P <sub>D</sub>	200	mW	
Thermal Resistance Junction to Ambient	$R_{ heta JA}$	625	°C/W	
Junction temperature Range	TJ	-55 ~ <b>+</b> 150	°C	
Storage Temperature	T <sub>STG</sub>	-55 ~ <b>+</b> 150	℃	

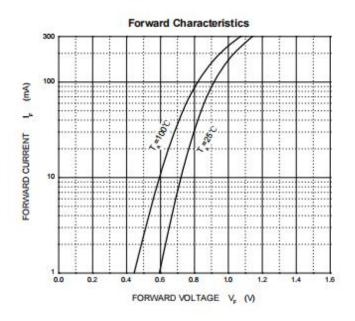
Electrical Specifications(TA=25°C unless otherwise noted)					
Parameter	Symbol	Test Conditions	Limits		Unit
			Min	Max	Uill
Reverse Breakdown Voltage	$V_{BR}$	$I_R = 2.5 \mu A$	75		V
Reverse Leakage Current	I <sub>R</sub>	V <sub>R</sub> = 20V		25	nA
		$V_R = 75V$		2.5	uA
Forward Voltage	V <sub>F</sub>	$I_F = 1.0 \text{mA}$		0.715	V
		$I_F = 10mA$		0.855	V
		$I_F = 50mA$		1	V
		I <sub>F</sub> = 150mA		1.25	V
Junction Capacitance	CJ	$V_R = 0, f = 1.0MHz$		2	pF

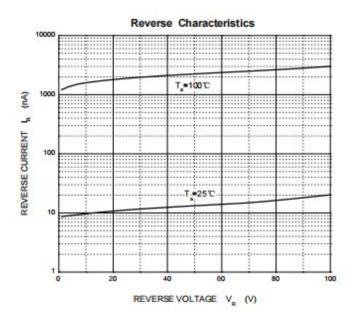


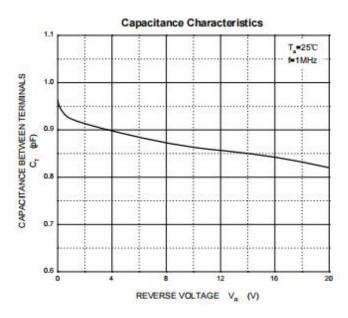


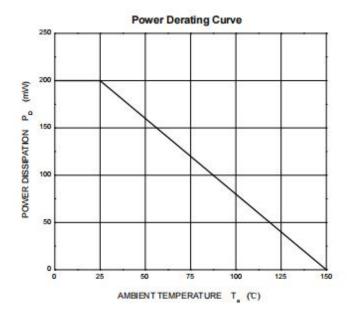
# **Ratings and Characteristics Curves**

(TA = 25°C unless otherwise noted)







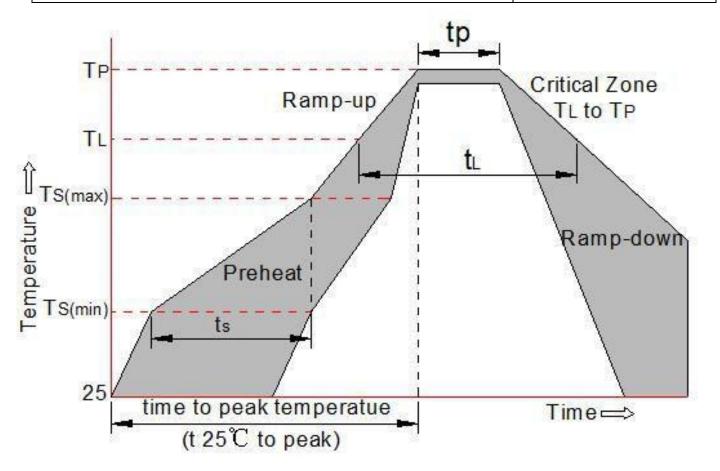






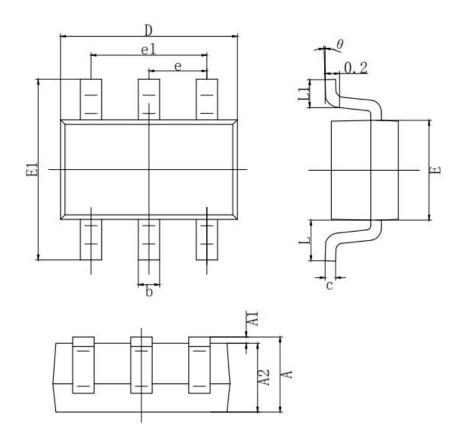
## **Soldering Parameters**

Reflow Condition		Pb -Free assembly (see as bellow)	
	-Temperature Min (T s(min) )	+150 ℃	
Pre Heat	-Temperature Max(T s(max))	+200 ℃	
. To Hout	-Time (Min to Max) (ts)	60 -180 secs.	
Average ra	amp up rate (Liquid us Temp (T L) to peak)	3 ℃ /sec. Max	
	Ts(maxtp T L- Ramp -up Rate	3 ℃ /sec. Max	
	-Temperature(T L) (Liquid us)	+217 ℃	
Reflow	-Temperature(t L)	60 -150 secs.	
Peak Temp (T p)		+260(+0/ -5) °C	
Tin	ne within 5 °C of actual Peak Temp (tp)	30 secs. Max	
Ramp -down Rate		6 °C /sec. Max	
Time 25 °C to Peak Temp (TP)		8 min. Max	
Do not exceed		+260 ℃	





# Package Outline Dimensions in inches (millimeters)



	MILLIMETER		
SYMBOL	MIN	MAX	
A	0.900	1. 100	
A1	0.000	0. 100	
A2	0.900	1.000	
b	0. 150	0. 350	
С	0.080	0. 150	
D	2.000	2. 200	
Е	1. 150	1. 350	
E1	2. 150	2. 450	
e	0. 650 TYP.		
el	1. 200	1. 400	
L	0. 525 REF.		
L1	0. 260	0. 460	
θ	0°	8°	

# **Revision History**

<b>Document Version</b>	Date of release	Description of changes	
Rev.A	2017.06.13	First issue	





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